

OK TO ENTER: /A.G./ (03/28/2010)

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Wood et al.

Serial No.: 10/666,742

Filed: September 19, 2003

For: METHODS FOR THINNING
SEMICONDUCTOR SUBSTRATES THAT
EMPLOY SUPPORT STRUCTURES
FORMED ON THE SUBSTRATES
(Amended)

Confirmation No.: 6057

Examiner: A. Ghyka

Group Art Unit: 2812

Attorney Docket No.: 2269-6095US
(2003-0593.00/US)

Notice of Allowance Dated:

December 17, 2009

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VIA ELECTRONIC FILING
March 15, 2010

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Serial No. 10/666,742

Amendments to the specification begin on page 3 of this paper;

A listing of the claims begins on page 5 of this paper; and

Remarks start at page 8 of this paper.

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